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Renesas Electronics Corporation

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H8/300L SLP Series

Example of Connecting the MAXIM SD ADC (16 Bits)

Introduction

The 16-bit MAX1408 $\Sigma\Delta$ A/D conversion results are serially input to the H8/38024 CPU by providing a clock, and the outputs are displayed on an array of 7-segment LEDs as a 4-digit hexadecimal number.

Target Device

H8/300L Super Low Power Series H8/38024 CPU

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1. Specifications

- Figure 1 shows an example of the hardware configuration required to connect a serial output analog/digital converter (hereinafter referred to as an ADC). Analog voltages are input to analog input pin 0 (IN0 pin) of the ADC and are then A/D converted by the 16-bit delta sigma modulator.
- The conversion results are input to the microcomputer by using the clock applied by the microcomputer through synchronous serial communication.
- The received 16-bit data is converted to a 4-digit hexadecimal number and the result is displayed on a 7-segment LED array.

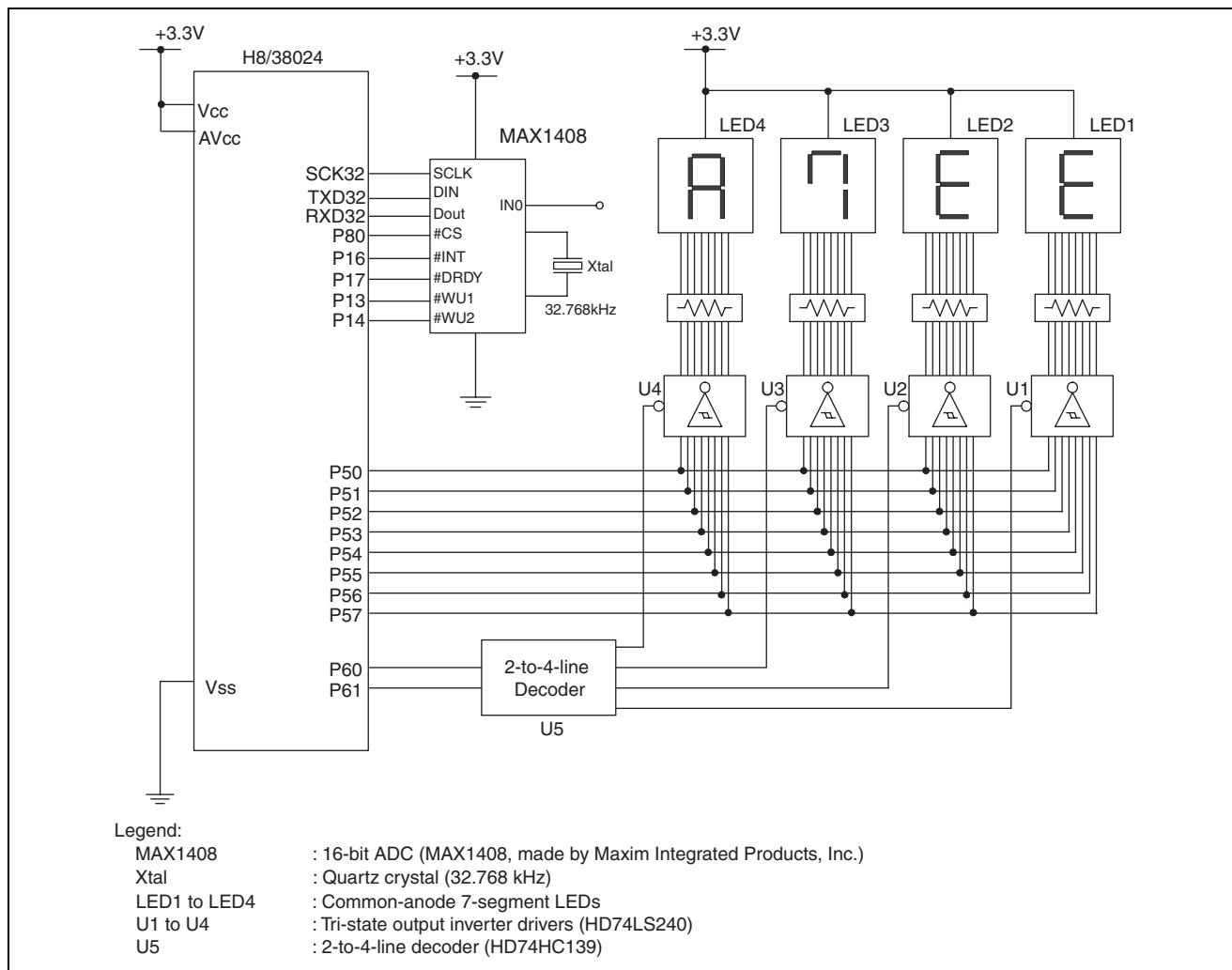


Figure 1 Hardware Configuration

- In this sample task, the operating voltage (Vcc) and analog power supply voltage (AVcc) of the H8/38024 are both 3.3 V, the OSC clock frequency is 10 MHz, and the watch clock frequency is 32.768 kHz.
- The ADC used in this sample task is a serial-output analog digital converter (model MAX1408) manufactured by Maxim Integrated Products, Inc. The specifications are as follows:
 - Characteristics of the MAX1408.
 - Power voltage: +2.7 V to +3.6 V

- b. Power consumption: 1.15mA (2.5 μ A in the sleep mode)
 - c. Package: 28-pin SSOP
 - d. Multi-channel 16-bit sigma-delta ADC
- B. The MAX1418 incorporates a delta-sigma modulator for A/D conversion. Since the converter has a high 16-bit resolution, it can be used for medical equipment, industrial controllers, portable devices, automatic metering, and robots.
- 6. The circuit in this sample task operates as follows.
 - A. Voltages input from analog pin 0 (IN0) of the MAX1418 are delta-sigma converted in cooperation with an external crystal resonator.
 - B. The 16-bit A/D converted data is input to the microcomputer by providing a serial clock.
 - C. The input 16-bit data is converted to a 4-digit hexadecimal number and displayed on the LED array.
 - D. For example, when a voltage of 0.82 V is applied to the IN0 pin, A/D conversion produces "1010 0111 1110 1110". The microcomputer then latches and converts it and then generates hexadecimal "A7EE" for the LED display.
 - E. A reference voltage of "1.25" is displayed on the LEDs as "FFFF" while 0 V is displayed as "0000".
- 7. In this sample task, the 7-segment LED display is set up by connecting the port outputs to the tri-state output inverter drivers (HD74LS240) and connecting the driver outputs to the cathodes of the 7-segment LEDs. In addition, all the ports used for the four 7-segment LEDs are connected to the 7-segment LEDs and the enable pins of the tri-state inverter drivers are used to renew between the 7-segment LEDs. The signal generation for renewing between the LEDs is controlled by the two port outputs of a 2-to-4 line decoder (HD74HC139). Figure 2 illustrates the method of controlling the 7-segment LEDs.

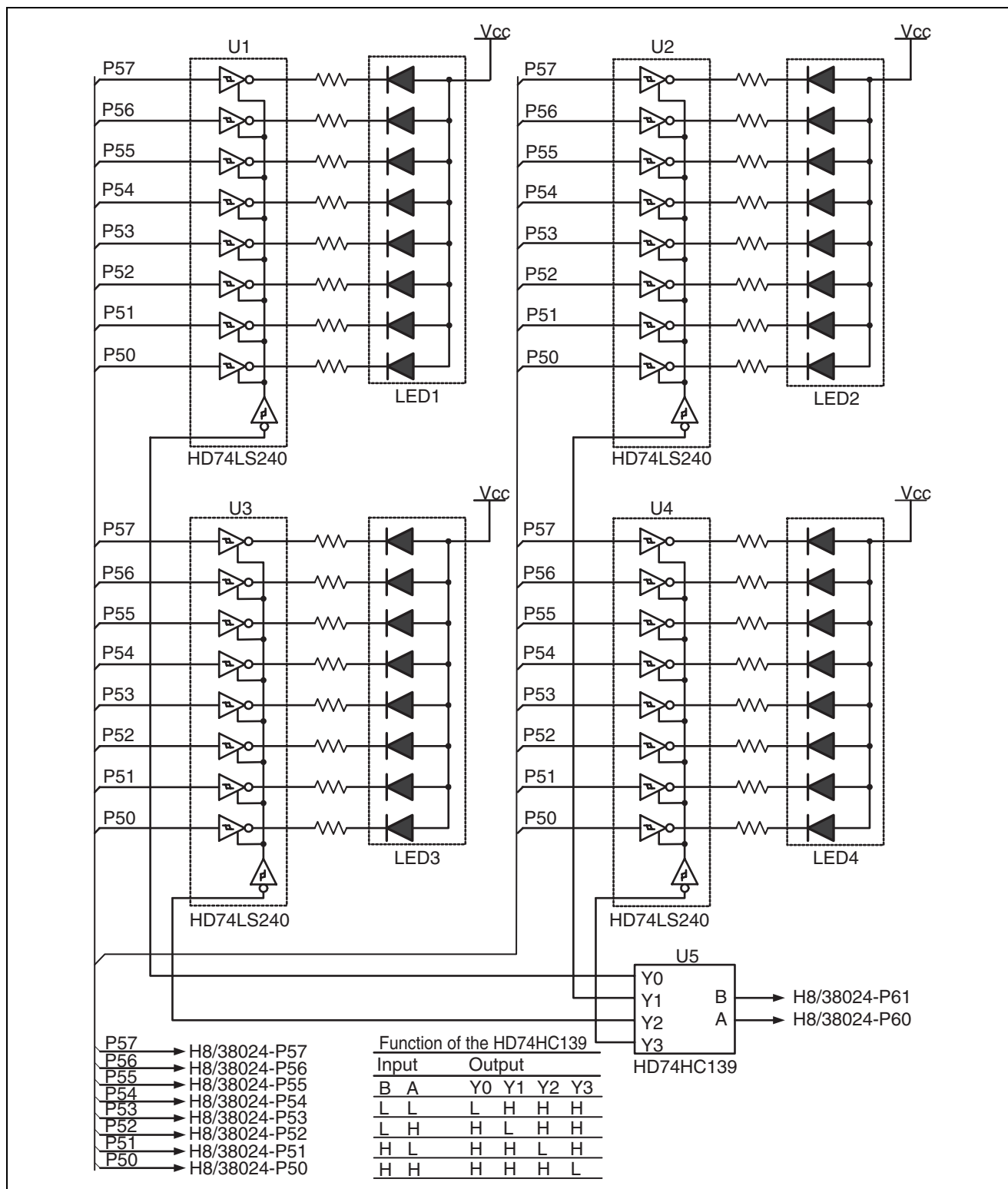


Figure 2 Method of Controlling 7-Segment LEDs

8. In this sample task, the 16-bit data obtained as the result of conversion by the MAX1408 $\Sigma\Delta$ A/D, is displayed on the 7-segment LED array as a 4-digit hexadecimal number. Figure 3 shows how the result of MAX1408 $\Sigma\Delta$ A/D conversion is displayed on the LEDs.

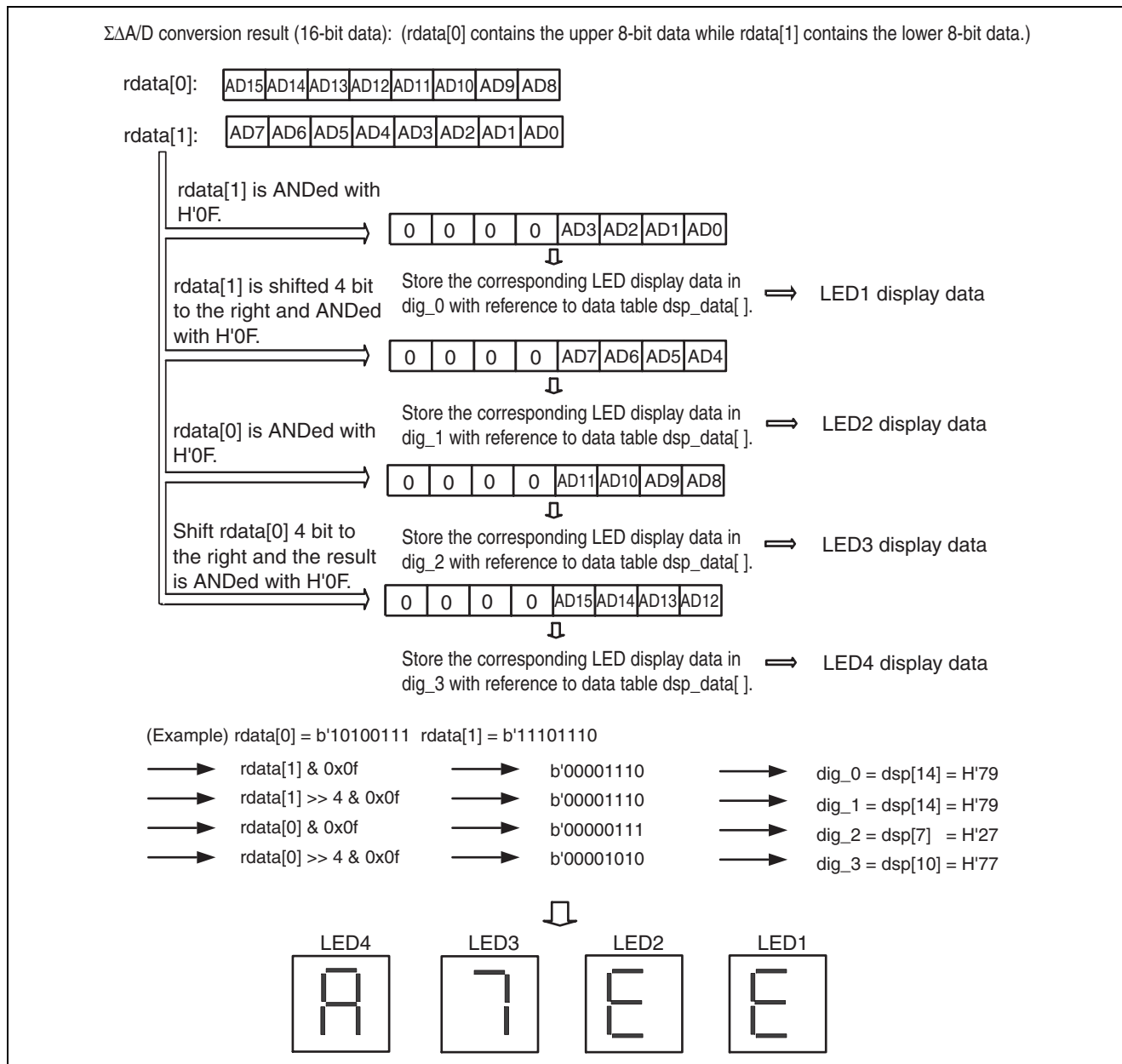


Figure 3 Display of Result of MAX1408 $\Sigma\Delta$ A/D Conversion on the LEDs

2. Description of Functions

1. Figure 4 is a block diagram of the H8/38024 functions used in this task. Table 1 lists the function allocations.

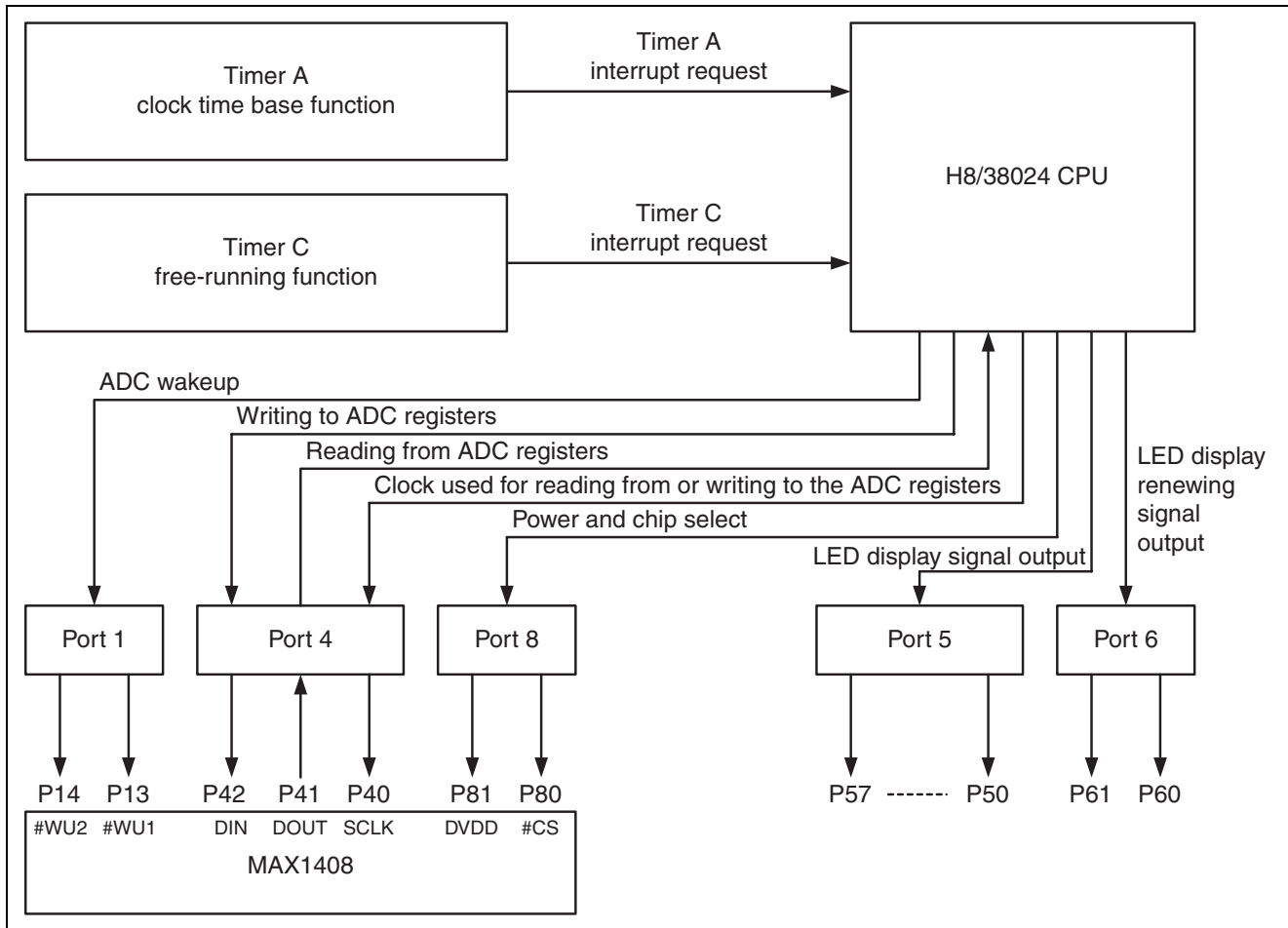


Figure 4 Block Diagram of Functions Used

Table 1 Function Assignments

Function	Function assignment
Timer A	The clock time base function of timer A is used to convert the DATA register value, obtained as a result of MAX1408 $\Sigma\Delta$ A/D conversion, to LED display data. Then it is stored into RAM.
Timer C	The free-running function of timer C is used to control the renewing between the 7-segment LEDs. Each of the four 7-segment LEDs is lit in sequence at intervals of 3.2768 ms (the time at which timer C overflows), enabling dynamic illumination of the LEDs.
Port 1	The P13 and P14 output pins of port 1 are used to wake up the MAX1408 $\Sigma\Delta$ ADC.
Port 4	The P42 output pin of port 4 is used to write to the MAX1408 $\Sigma\Delta$ ADC registers. The P40 output pin of port 4 is used to set the clock for writing to or reading from the MAX1408 $\Sigma\Delta$ ADC registers. The P41 input pin of port 4 is used to read from the MAX1408 $\Sigma\Delta$ ADC registers.
Port 5	The P50-P57 output pins of port 5 are used to display data on the currently active 7-segment LED. The 10-bit data, obtained as a result of the MAX1408 $\Sigma\Delta$ A/D conversion, is converted to 4-digit hexadecimal display data and output to the LED.
Port 6	The P60 and P61 output pins of port 6 are used to renew between the four 7-segment LEDs. The P60 and P61 output pins are connected to the input pins of the 2-to-4 line decoder.
Port 8	The P80 and P81 output pins are used to connect to the power and chip select of the MAX1408 $\Sigma\Delta$ ADC.

2. Figure 5 shows how the 7-segment LED used in this task is connected. A high output from port 5 lights the corresponding segment of the LED, as shown in the figure. Table 2 lists the relationships between port 5 outputs and display on the LED display.

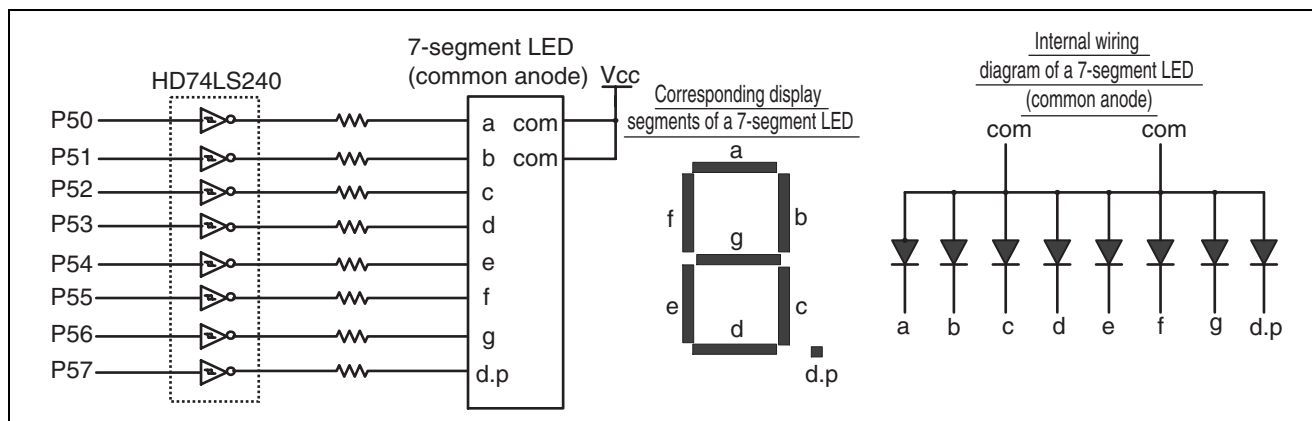
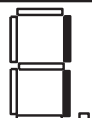


Figure 5 Connection Diagram and Internal Connections of 7-Segment LED

Table 2 Relationship between Port 5 Outputs and 7-Segment LED Display Data

LED display	Port 5 output data								LED display	Port 5 output data							
	P57	P56	P55	P54	P53	P52	P51	P50		P57	P56	P55	P54	P53	P52	P51	P50
	0	0	1	1	1	1	1	1		0	1	1	1	0	1	1	1
	0	0	0	0	0	1	1	0		0	1	1	1	1	1	0	0
	0	1	0	1	1	0	1	1		0	0	1	1	1	0	0	1
	0	1	0	0	1	1	1	1		0	1	0	1	1	1	1	0
	0	1	1	0	0	1	1	0		0	1	1	1	1	0	0	1
	0	1	1	0	1	1	0	1		0	1	1	1	0	0	0	1
	0	1	1	1	1	1	0	1									
	0	0	1	0	0	1	1	1									
	0	1	1	1	1	1	1	1									
	0	1	1	0	1	1	1	1									

3. Description of Operation

- Figure 6 shows how the 16-bit DATA register value, obtained as a result of MAX1408 $\Sigma\Delta$ A/D conversion, is converted to LED display data and then stored into RAM. In this sample task, the result of MAX1408 $\Sigma\Delta$ A/D conversion is converted to LED display data and stored into RAM at the timer A interrupt interval in the tmra routine, as shown in this figure.

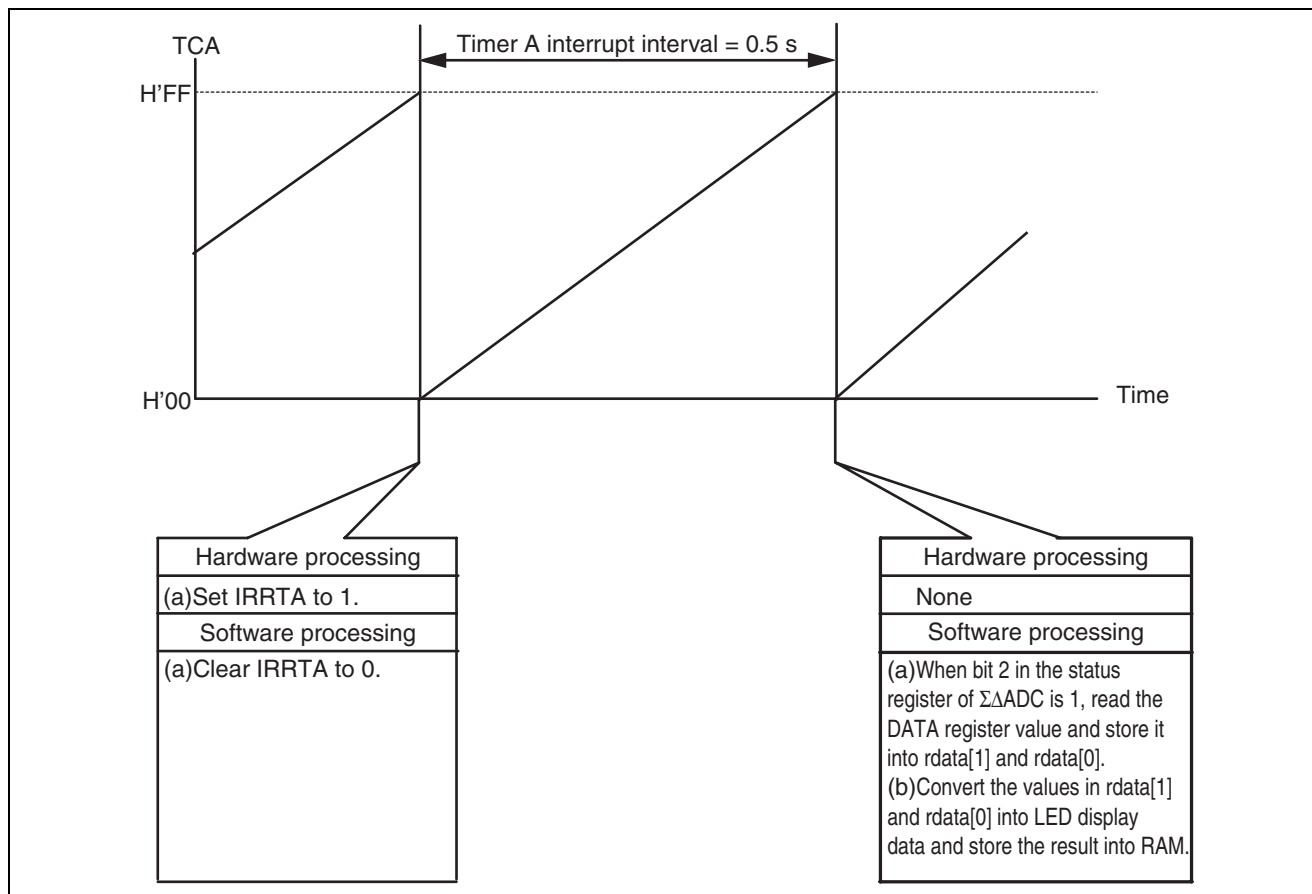


Figure 6 Description of Storing the $\Sigma\Delta$ A/D Conversion Result into RAM

2. The following describes the descriptions of 7-segment LED operation. Figure 7 shows how a value of "A7EE" is displayed on LED4 to LED1. As shown in the figure, each of LED1 to LED4 is lit in sequence at the timer C overflow interval, resulting in dynamic display on the 7-segment LED.

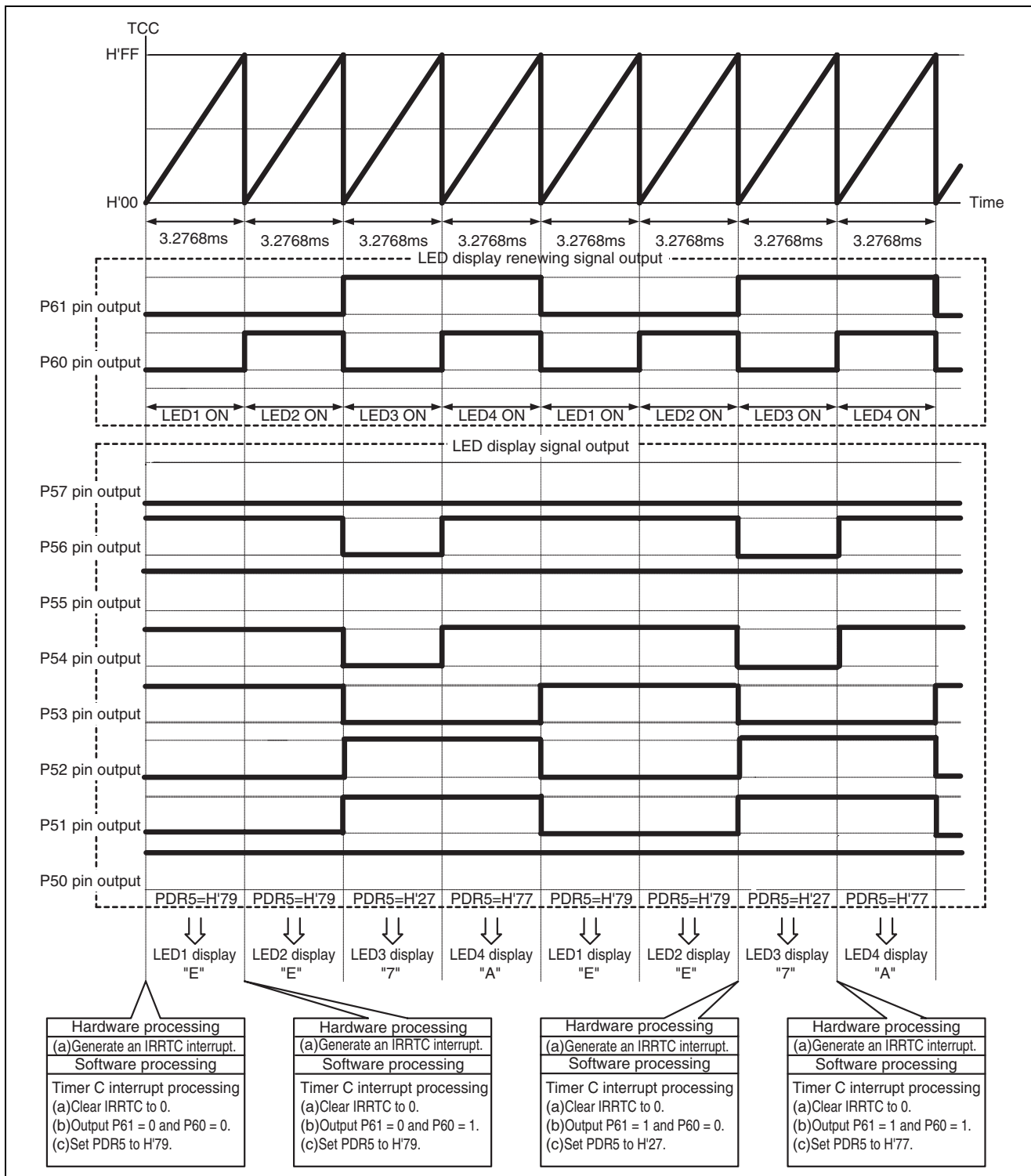


Figure 7 Descriptions of 7-Segment LED Display Control

4. Description of Software

1. Modules

Table 3 lists the modules used in this sample task.

Table 3 Modules

Module name	Label name	Function
Main routine	main	Makes the initial settings, calls the initial setting function for the MAX1408 $\Sigma\Delta$ A/D converter, and then enables an interrupt.
Timer A interrupt processing routine	tmra	Clears the interrupt flag. This routine also converts the DATA register value, obtained as a result of MAX1408 $\Sigma\Delta$ A/D conversion, to LED display data after bit 2 of the STATUS register is set to 1, and then stores it into RAM.
Timer C interrupt processing routine	tmrc	Clears the interrupt flag, outputs the LED display data, and controls LED display switching.
ADC_Init() processing routine	ADC_Init	Initializes the MAX1408 $\Sigma\Delta$ A/D converter.
DataIn() processing routine	DataIn	Writes to or reads from the MAX1408 $\Sigma\Delta$ A/D converter registers.
DataOut() processing routine	DataOut	Writes to the MAX1408 $\Sigma\Delta$ A/D converter registers.

2. Arguments

No arguments are used in this sample task.

3. Internal Registers

Table 4 lists the internal registers used in this task.

Table 4 Internal Registers

Register name	Description	Address	Setting
TMA	Timer mode register A: Selects a prescaler and input clock.	H'FFB0	H'0C (At initial setting)
TMA3	Internal clock select 3: Selects the operating mode of timer A. When TMA3 = 1, it functions as a clock time base that counts the output of prescaler W.	Bit 3	1
TMA2	Internal clock select 2-0: When TMA3 = 1, the clock time base (32.768kHz) is selected.	Bit 2	0/1
TMA1	When TMA2 = 1, TMA1 = 0, and TMA0 = 0, TCA reset is selected.	Bit 1	0
TMA0	When TMA2 = 0, TMA1 = 0, and TMA0 = 1, the TCA overflow period is 0.5 s.	Bit 0	0/1
TMC	Timer mode register C: Selects automatic reloading, controls count-up or count-down of the counter, and controls the input clock.	H'FFB4	H'1B
TMC7	Selects the automatic reload function: When TMC7 = 0, it selects the interval function.	Bit 7	0
TMC6	Controls counting-up or count-down:	Bit 6	0
TMC5	When TMC6 = 0 and TMC5 = 0, TCC functions as an up-counter.	Bit 5	0

Register name	Description	Address	Setting
TMC2	Clock select:	Bit 2	0
TMC1	When TMC2 = 0, TMC = 1, and TMC = 1, counting	Bit 1	1
TMC0	is performed using an internal clock of $\phi/64$.	Bit 0	1
TLC	Timer load register C: Sets the TCC reload value.	H'FFB5	H'00
CKSTRP1	Clock stop register 1: Bit 5: Controls module standby mode of SCI3. When this bit is 1, module standby mode of SCI3 is released.	H'FFFA	H'FF
PDR1	Port data register 1	H'FFD4	H'00
PCR1	Port control register 1: Specifies, bit-by-bit, whether each of the pins (P17, P16, P14, and P13) of port 1 is an input pin or output pin. When PCR1 = H'3F, the P14 and P13 pins function as output pins.	H'FFE4	H'3F
PUCR1	Port pull-up control register 1: Controls, bit-by-bit, the pull-up MOS of each of P17, P16, P14, and P13. When PUCR1 = H'00, the pull-up MOS for the P17, P16, P14, and P13 is off.	H'FFE0	H'00
PMR1	Port mode register 1:	H'FFC8	H'42
IRQ3	P17/IRQ3/TMIF pin function switching: When this bit is 0, this pin functions as the P17 general I/O port.	Bit 7	0
IRQ4	P14/IRQ4/ADTRG pin function switching: When this bit is 0, this pin functions as the P14 general I/O port.	Bit 4	0
TMIG	P13/TMIG pin function switching: When this bit is 0, this pin functions as the P13 general I/O port.	Bit 3	0
PMR2	Port mode register 2: Turns the PMOS for the P35 pin on or off, selects a watchdog timer clock, selects TMIG noise cancel, and controls P43/IRQ0 pin function switching.	H'FFC9	H'D8
PDR4	Port data register 4	H'FFD7	H'F8
PCR4	Port control register 4: Specifies, bit-by-bit, whether the pins (P42-P40) of port 4 is an input pin or output pin. When PCR4 = H'FD, the P42 and P40 pins function as output pins and the P41 pin functions as an input pin.	H'FFE7	H'FD
PUCR6	Port pull-up control register 6: Controls, bit-by-bit, the pull-up MOS of each pin of port 6 that is set as an input port. When PUCR6 = H'00, the pull-up MOS for the P67-P60 pins is off.	H'FFE3	H'00
PDR6	Port data register 6: General I/O port data register for port 6	H'FFD9	H'00

Register name	Description	Address	Setting
PCR6	Port control register 6: Selects bit-by-bit, whether each pin used as a general I/O port for port 6 is an input pin or output pin. When PCR6 = H'FF, the P67-P60 pins function as general output pins.	H'FFE9	H'FF
PMR5	Port mode register 5: Sets the pin function of port 5.	H'FFCC	H'00
WKP7	P57/_WKP7/SEG7 pin function switching: When this bit is 0, the P57 general I/O port function is selected.	Bit 7	0
WKP6	P56/_WKP6/SEG6 pin function switching: When this bit is 0, the P56 general I/O port function is selected.	Bit 6	0
WKP5	P55/_WKP5/SEG5 pin function switching: When this bit is 0, the P55 general I/O port function is selected.	Bit 5	0
WKP4	P54/_WKP4/SEG4 pin function switching: When this bit is 0, the P54 general I/O port function is selected.	Bit 4	0
WKP3	P53/_WKP3/SEG3 pin function switching: When this bit is 0, the P53 general I/O port function is selected.	Bit 3	0
WKP2	P52/_WKP2/SEG2 pin function switching: When this bit is 0, the P52 general I/O port function is selected.	Bit 2	0
WKP1	P51/_WKP1/SEG1 pin function switching: When this bit is 0, the P51 general I/O port function is selected.	Bit 1	0
WKP0	P50/_WKP0/SEG0 pin function switching: When this bit is 0, the P50 general I/O port function is selected.	Bit 0	0
PUCR5	Port pull-up control register 5: Controls, bit-by-bit, the pull-up MOS of each pin of port 5 that is set as an input port. When PUCR5 = H'00, the pull-up MOS for the P57-P50 pins is off.	H'FFE2	H'00
PDR5	Port data register 5: General I/O port data register for port 5:	H'FFD8	H'00
PCR5	Port control register 5: Selects, bit-by-bit, whether each pin used as a general I/O port for port 5 is an input pin or output pin. When PCR5 = H'FF, the P57-P50 pins function as general output pins.	H'FFE8	H'FF
PDR8	Port data register 8: General I/O port data register for port 8	H'FFDB	H'00

4. Description of RAM

Table 5 describes the RAM used in this sample task.

Table 5 Description of RAM

Label name	Description	Address	Module label name
ptr	Location where the address of Dig_0 is stored	H'FB82	tmrc,
dig_0	Stores LED1 display data (1 byte)	H'FB84	main, tmra, tmrc
dig_1	Stores LED2 display data (1 byte)	H'FB85	main, tmra, tmrc
dig_2	Stores LED3 display data (1 byte)	H'FB86	main, tmra, tmrc
dig_3	Stores LED4 display data (1 byte)	H'FB87	main, tmra, tmrc
cnt	8-bit counter for renewing display between LED1-LED4 (1 byte)	H'FB88	main, ttmrc
sdata	Stores a register value for controlling MAX1408 $\Sigma\Delta$ A/D	H'FB89	tmra, ADC_Init, DataIn, DataOut
rdata	Stores the DATA register value that results from MAX1408 $\Sigma\Delta$ A/D conversion.	H'FB8E	tmra, DataIn,

5. Description of Data Tables

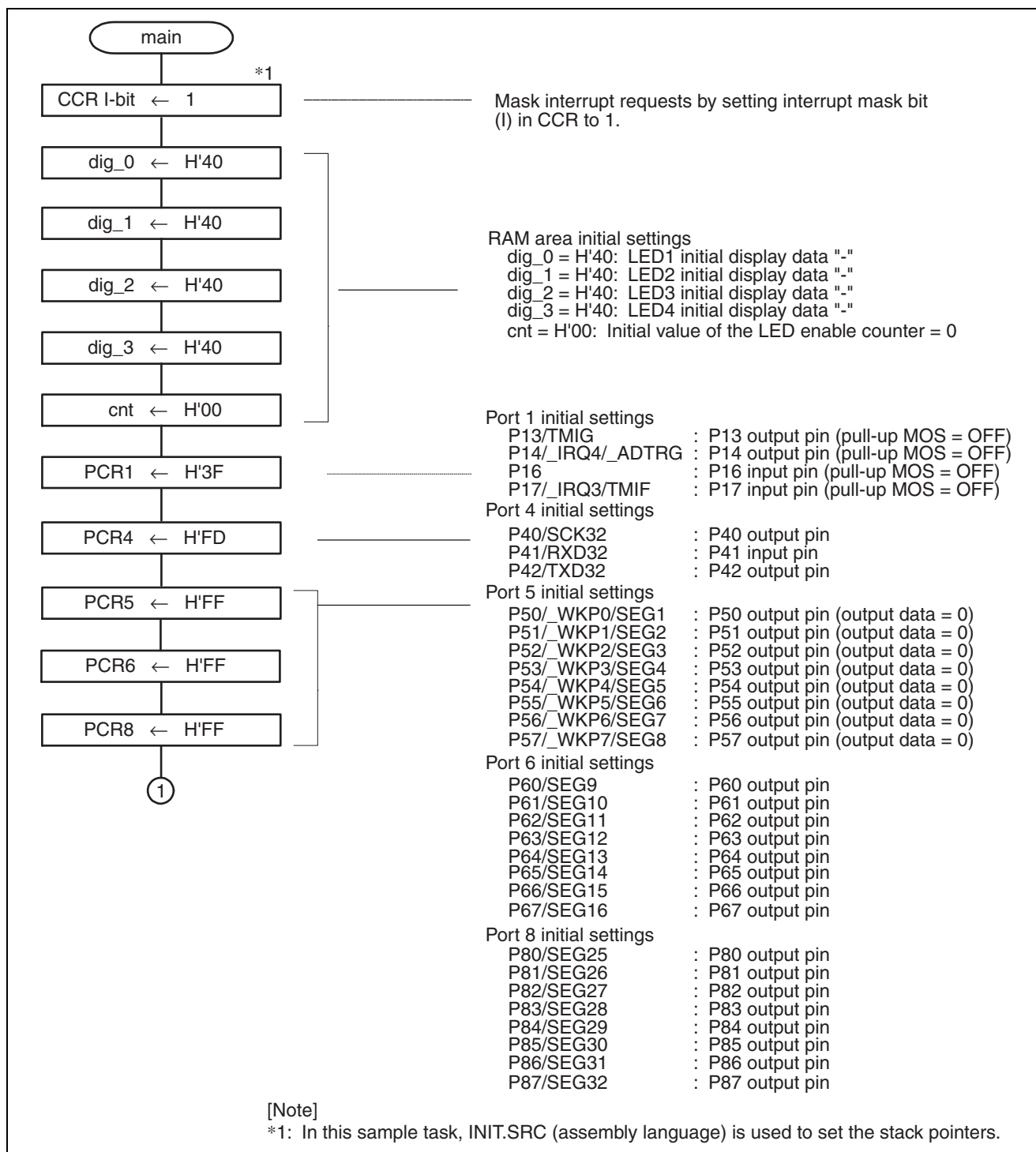
In this sample task, display data for the 7-segment LEDs is stored in ROM as a data table consisting of a 1-dimensional array (data table). Table 6 describes the data table for 7-segment LED display (dsp_data []).

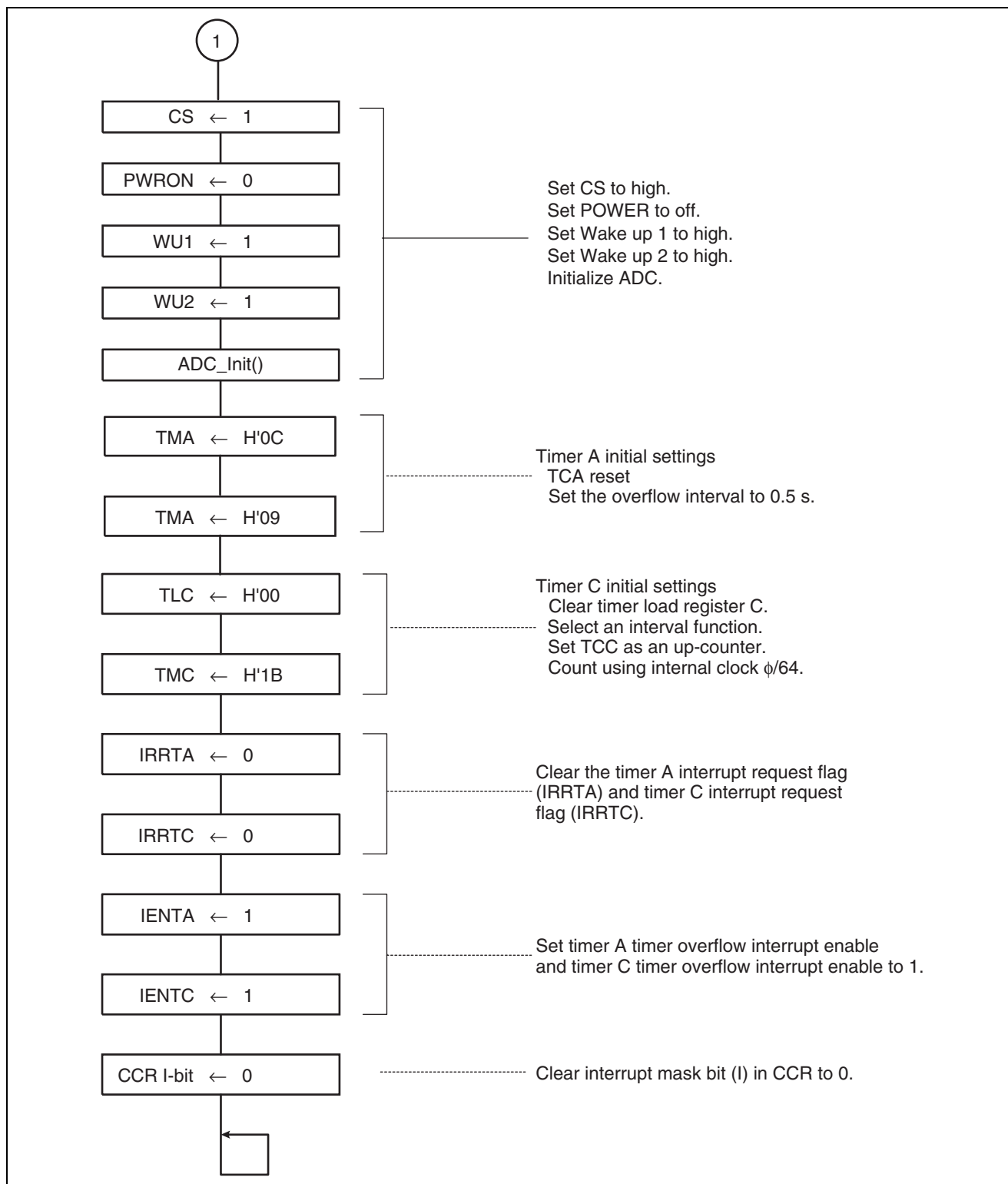
Table 6 Description of Data Table (dsp_data[]) for 7-Segment LED Display

Element	Data	Description	Data size	Address
dsp_data[0]	H'3F	Port 5 output data for displaying "0" on a LED	1 byte	H'7B4
dsp_data[1]	H'06	Port 5 output data for displaying "1" on a LED	1 byte	H'7B5
dsp_data[2]	H'5B	Port 5 output data for displaying "2" on a LED	1 byte	H'7B6
dsp_data[3]	H'4F	Port 5 output data for displaying "3" on a LED	1 byte	H'7B7
dsp_data[4]	H'66	Port 5 output data for displaying "4" on a LED	1 byte	H'7B8
dsp_data[5]	H'6D	Port 5 output data for displaying "5" on a LED	1 byte	H'7B9
dsp_data[6]	H'7D	Port 5 output data for displaying "6" on a LED	1 byte	H'7BA
dsp_data[7]	H'27	Port 5 output data for displaying "7" on a LED	1 byte	H'7BB
dsp_data[8]	H'7F	Port 5 output data for displaying "8" on a LED	1 byte	H'7BC
dsp_data[9]	H'6F	Port 5 output data for displaying "9" on a LED	1 byte	H'7BD
dsp_data[10]	H'77	Port 5 output data for displaying "A" on a LED	1 byte	H'7BE
dsp_data[11]	H'7C	Port 5 output data for displaying "B" on a LED	1 byte	H'7BF
dsp_data[12]	H'39	Port 5 output data for displaying "C" on a LED	1 byte	H'7C0
dsp_data[13]	H'5E	Port 5 output data for displaying "D" on a LED	1 byte	H'7C1
dsp_data[14]	H'79	Port 5 output data for displaying "E" on a LED	1 byte	H'7C2
dsp_data[15]	H'71	Port 5 output data for displaying "F" on a LED	1 byte	H'7C3

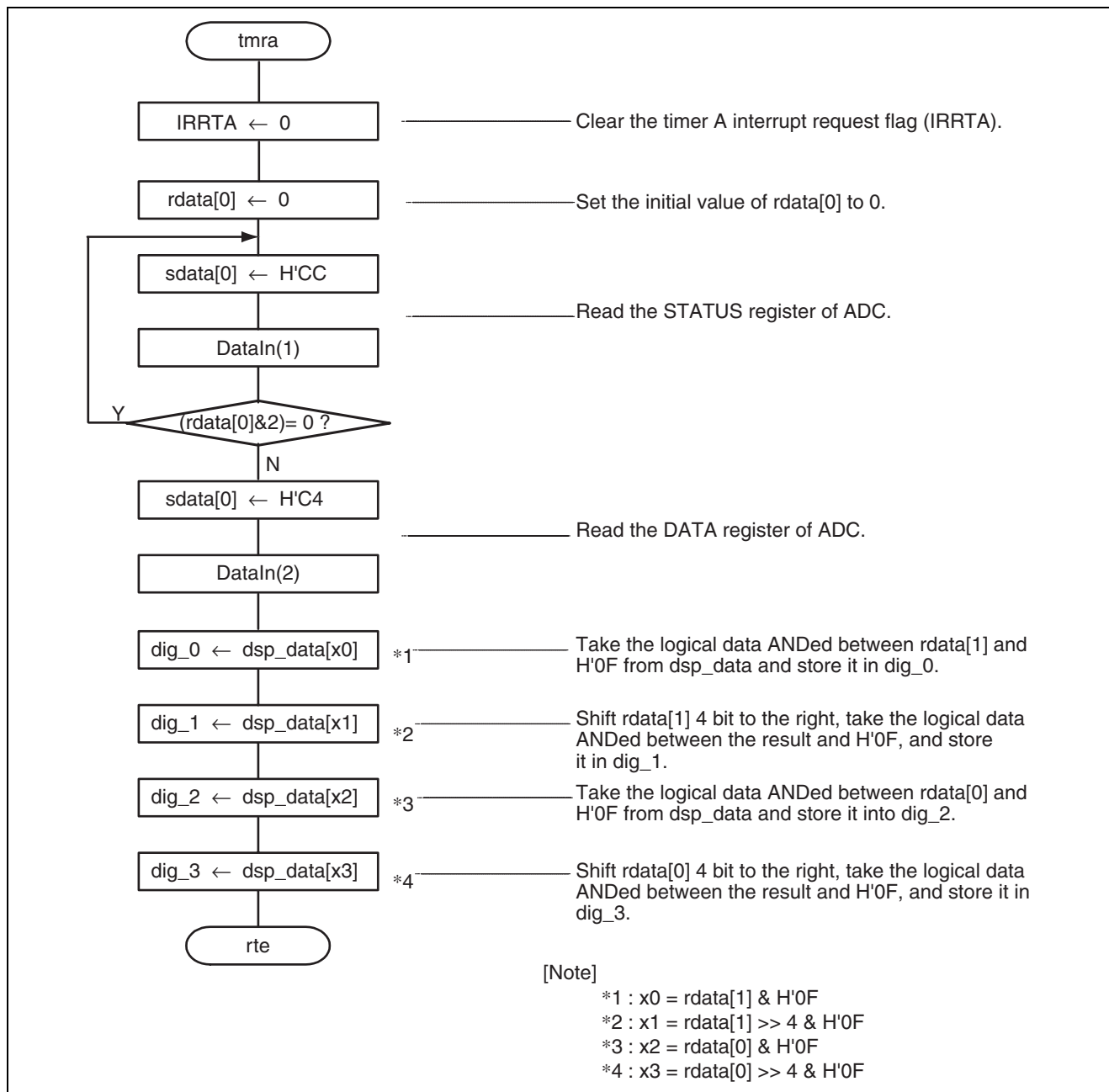
5. Flowchart

1. Main Routine (main)

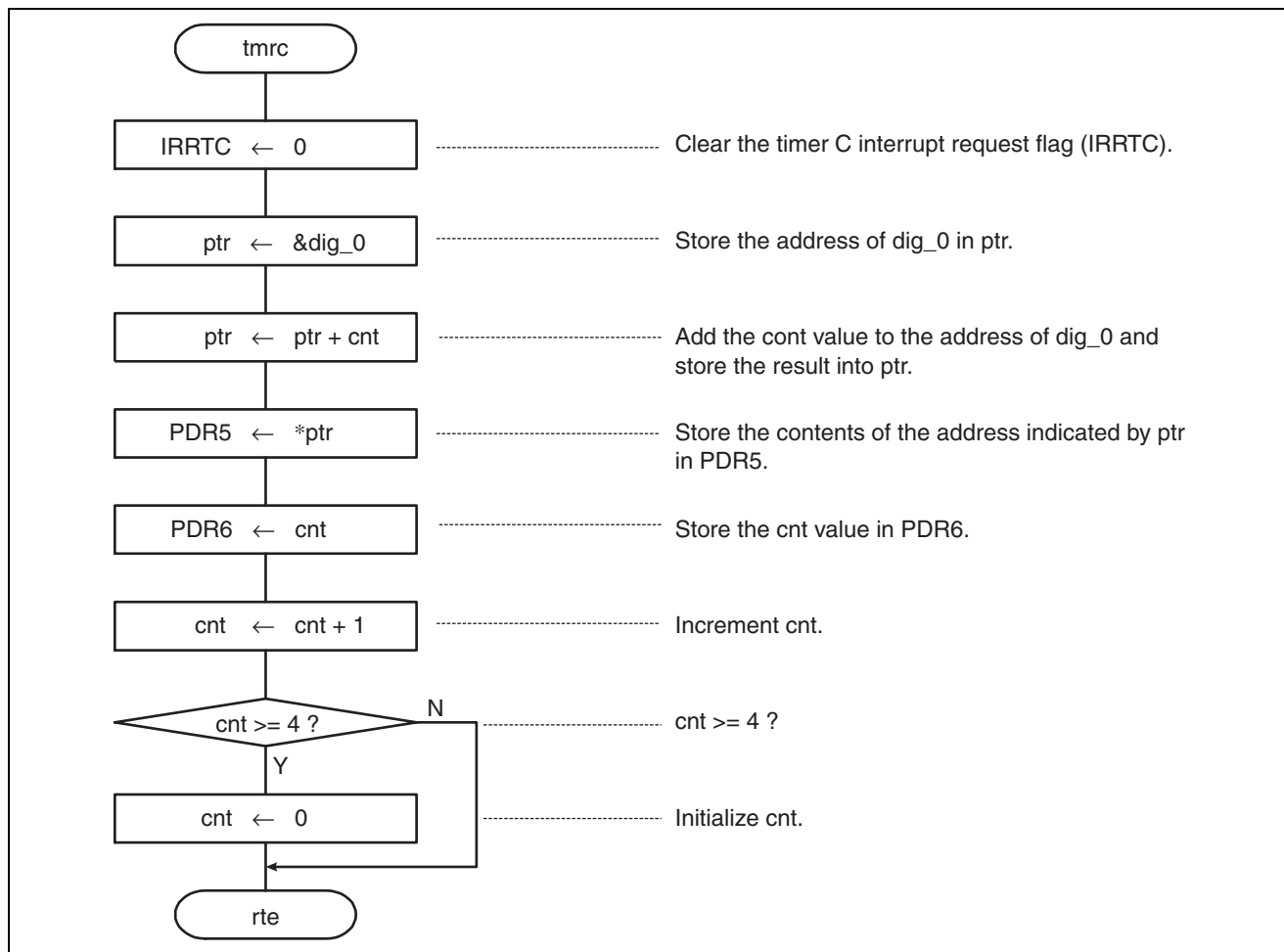




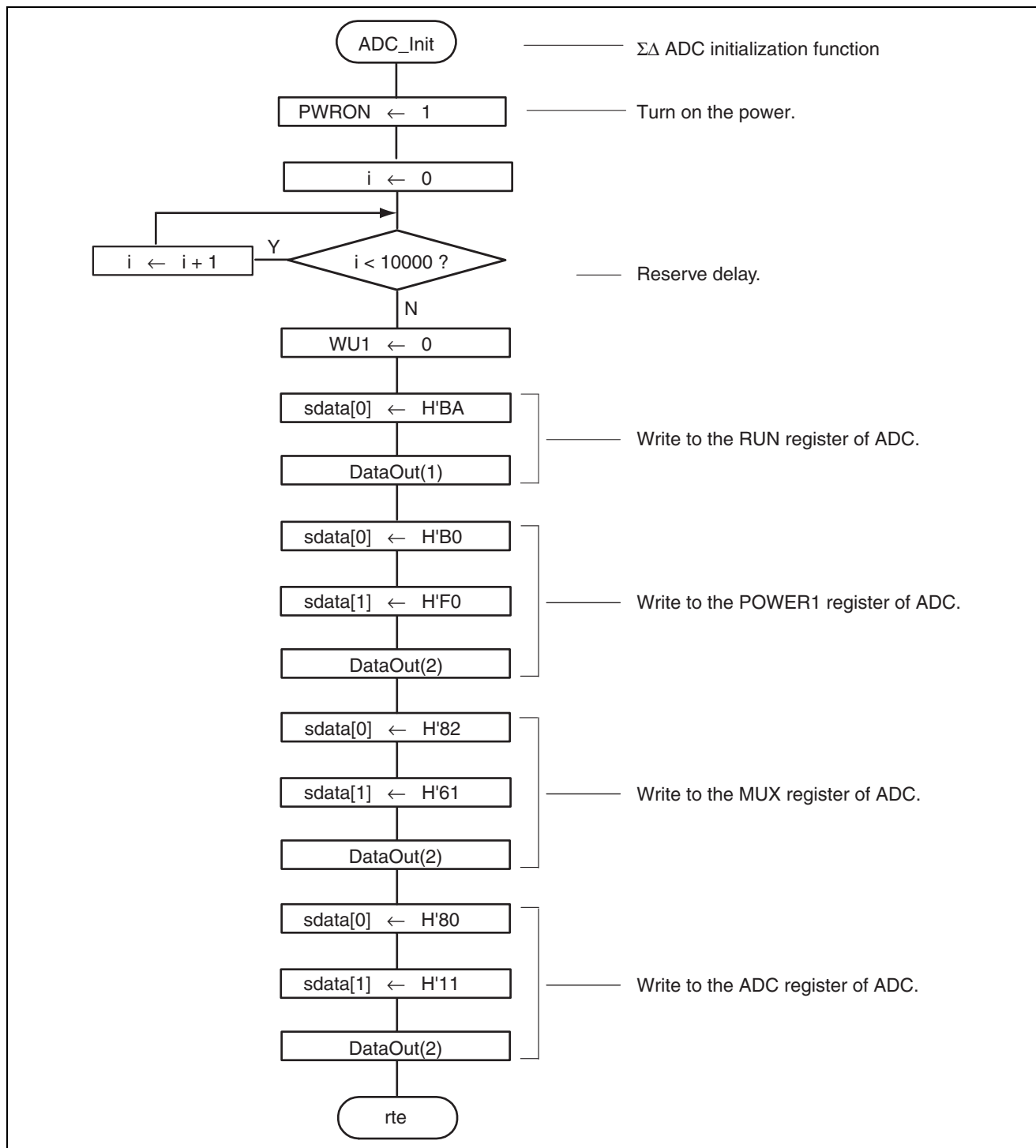
2. Timer A Interrupt Processing Routine (tmra)



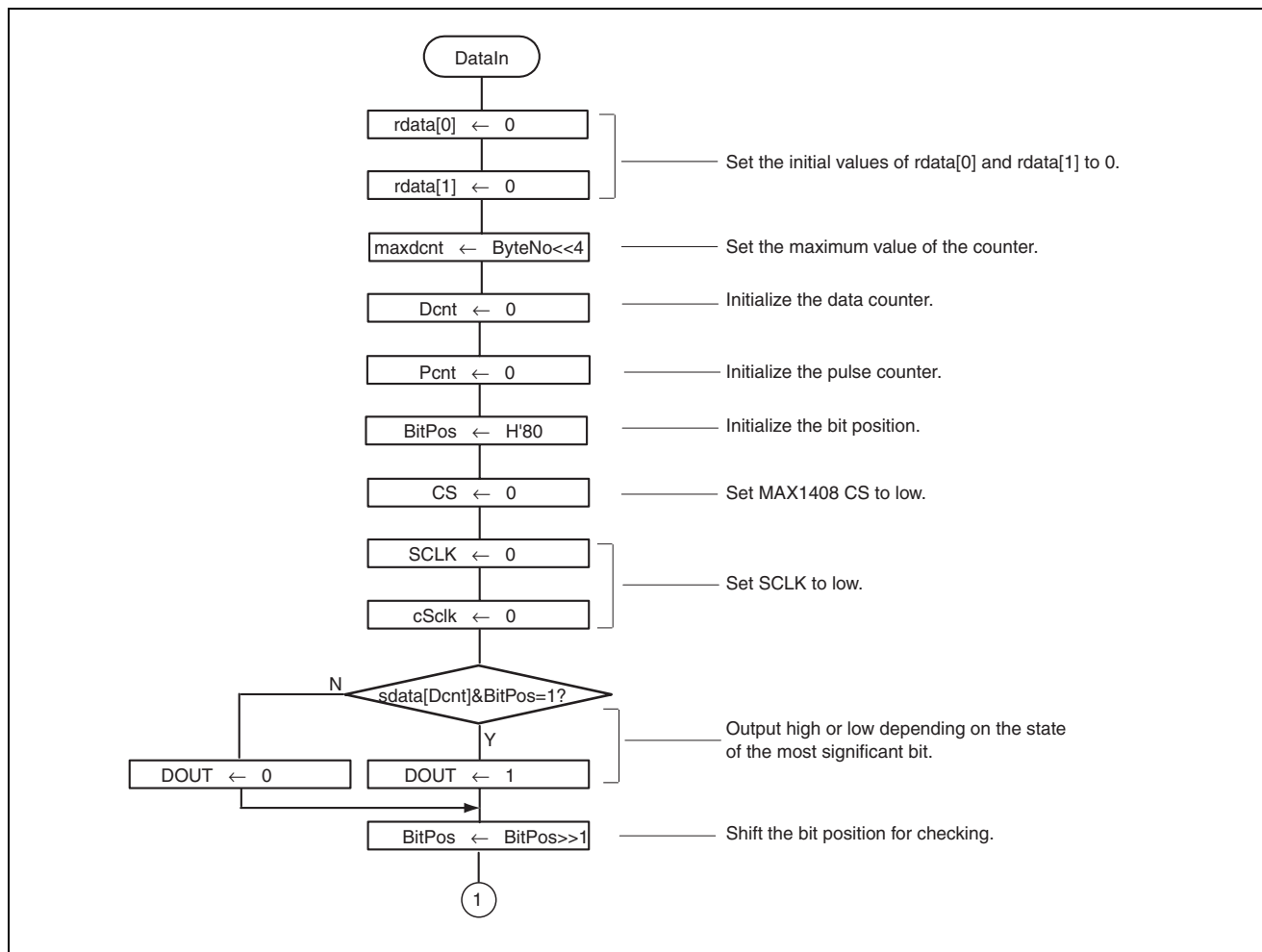
3. Timer C Interrupt Processing Routine (tmrc)

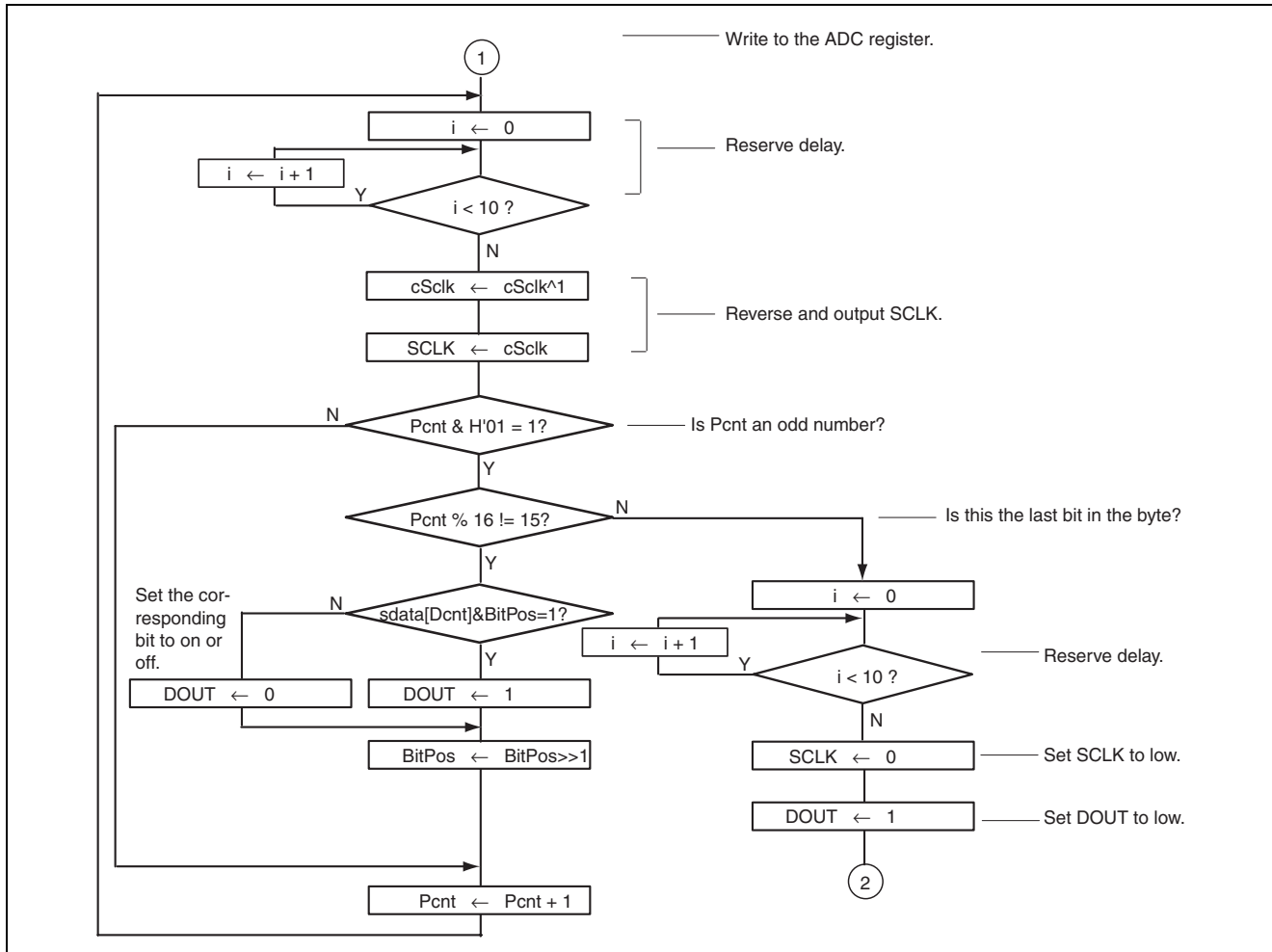


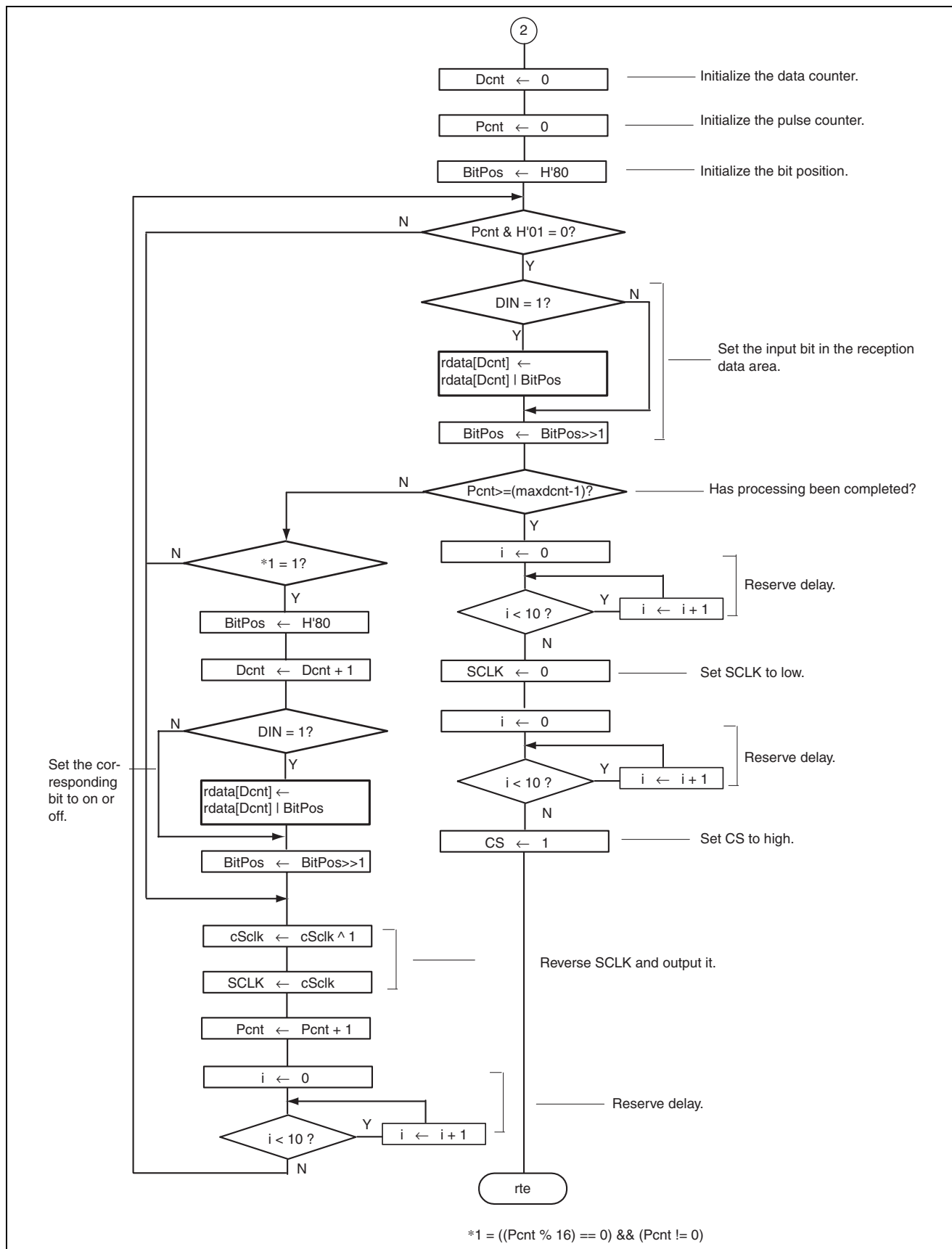
4. ADC_Init() Processing Routine



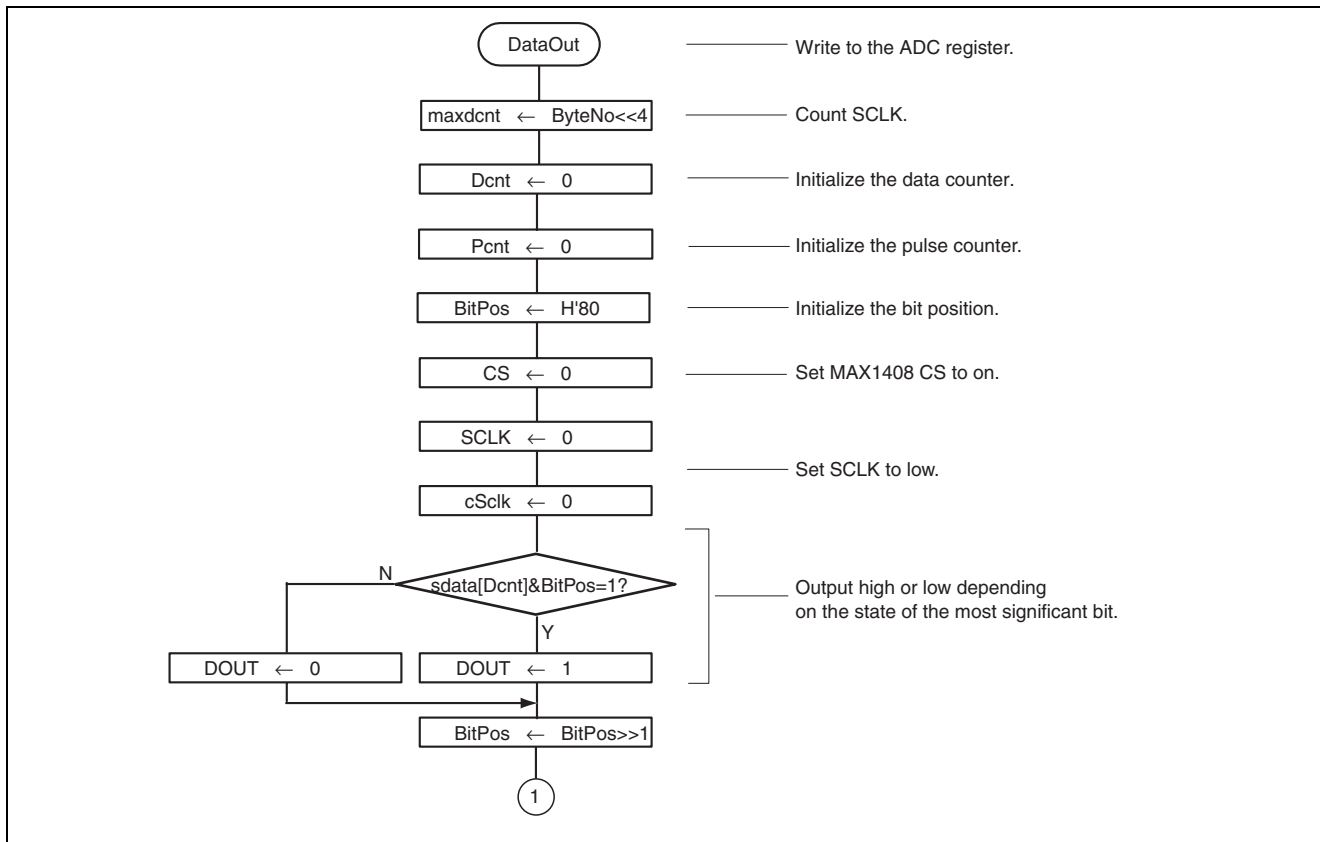
5. DataIn() Processing Routine

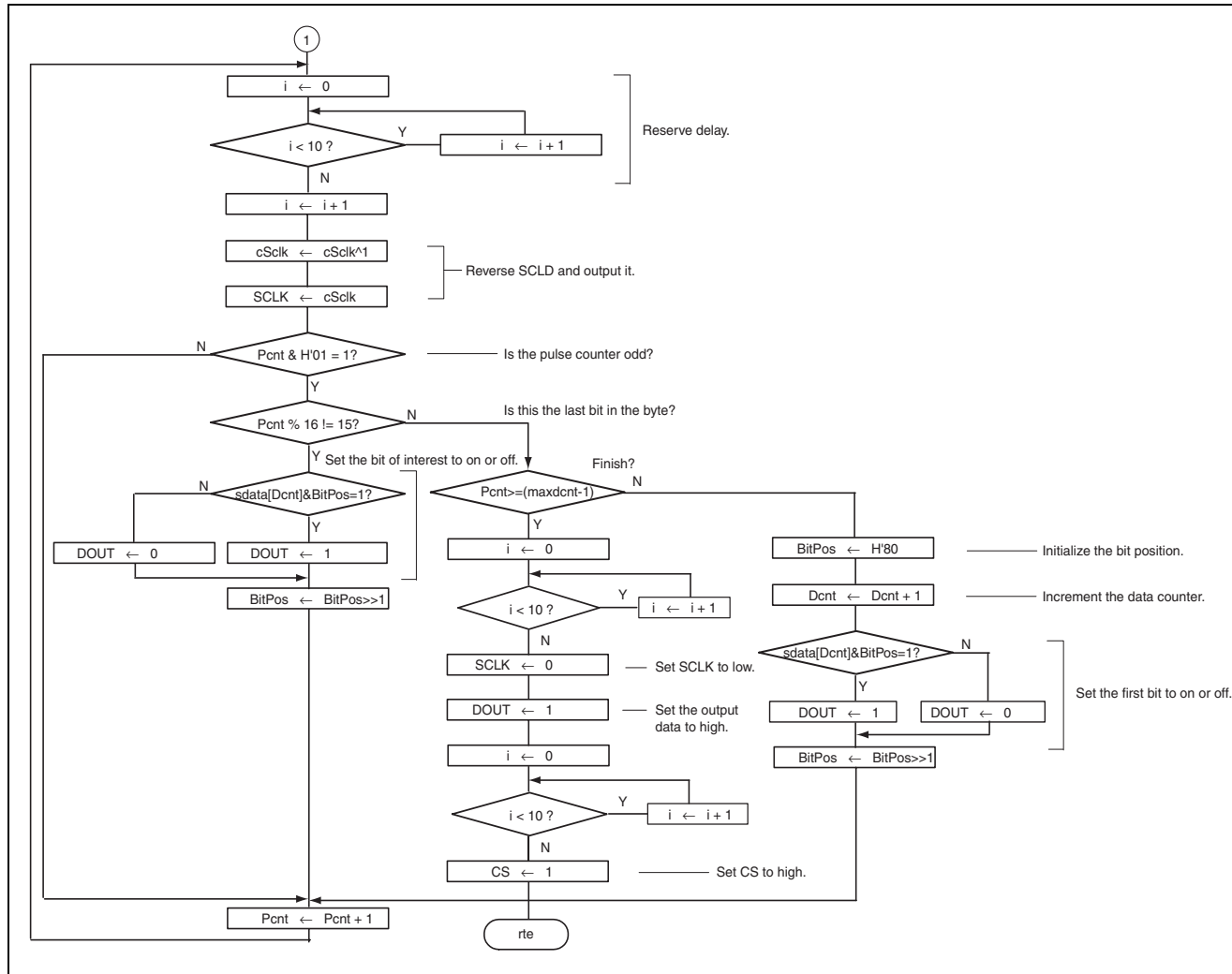






6. DataOut() Processing Routine





6. Program Listing

```

/* Super Low Power Series -H8/38024- Application note */
/* Application example */
/* Example of connecting to ΣΔ ADC */

#include <machine.h>

/* Symbol definition */
struct BIT {
    unsigned char b7:1;          /* bit 7 */
    unsigned char b6:1;          /* bit 6 */
    unsigned char b5:1;          /* bit 5 */
    unsigned char b4:1;          /* bit 4 */
    unsigned char b3:1;          /* bit 3 */
    unsigned char b2:1;          /* bit 2 */
    unsigned char b1:1;          /* bit 1 */
    unsigned char b0:1;          /* bit 0 */
};

#define PDR1    *(volatile unsigned char *)0xFFD4    /* Port data register 1 */
#define PCR1    *(volatile unsigned char *)0xFFE4    /* Port control register 1 */
#define PUCR1   *(volatile unsigned char *)0xFFE0    /* Port pull-up control register 1 */
#define PMR1    *(volatile unsigned char *)0xFFC8    /* Port mode register 1 */
#define PMR2    *(volatile unsigned char *)0xFFC9    /* Port mode register 2 */
#define PDR1_BIT (*(struct BIT *)0xFFD4)
#define WU1     PDR1_BIT.b3          /* MAX1408 WU1 */
#define WU2     PDR1_BIT.b4          /* MAX1408 WU2 */

#define PDR4    *(volatile unsigned char *)0xFFD7    /* Port data register 4 */
#define PCR4    *(volatile unsigned char *)0xFFE7    /* Port control register 4 */
#define PDR4_BIT (*(struct BIT *)0xFFD7)
#define SCLK    PDR4_BIT.b0          /* MAX1408 SCLK */
#define DOUT    PDR4_BIT.b2          /* MAX1408 DOUT */
#define DIN     PDR4_BIT.b1          /* MAX1408 DIN */

#define PMR5    *(volatile unsigned char *)0xFFC5    /* Port mode register 5 */
#define PUCR5   *(volatile unsigned char *)0xFFE2    /* Port pull-up control register 5 */
#define PDR5    *(volatile unsigned char *)0xFFD8    /* Port data register 5 */
#define PCR5    *(volatile unsigned char *)0xFFE8    /* Port control register 5 */

#define PUCR6   *(volatile unsigned char *)0xFFE3    /* Port pull-up control register 6 */
#define PDR6    *(volatile unsigned char *)0xFFD9    /* Port data register 6 */
#define PCR6    *(volatile unsigned char *)0xFFE9    /* Port control register 6 */

#define PDR8    *(volatile unsigned char *)0xFFDB    /* Port data register 8 */
#define PCR8    *(volatile unsigned char *)0xFFEB    /* Port control register 8 */
#define PDR8_BIT (*(struct BIT *)0xFFDB)
#define CS      PDR8_BIT.b0          /* MAX1408 #CS */
#define PWRON   PDR8_BIT.b1          /* MAX1408 POWER */

#define TMA     *(volatile unsigned char *)0xFFB0    /* Timer mode register A */

```

```
#define CKSTPR1    *(volatile unsigned char *)0xFFFA /* Clock stop register 1 */

#define TMC        *(volatile unsigned char *)0xFFB4 /* Timer mode register C */
#define TLC        *(volatile unsigned char *)0xFFB5 /* Timer Load register C */

#define IRR1       *(volatile unsigned char *)0xFFF6 /* Interrupt request register 1 */
#define IRR1_BIT   (*(struct BIT *)0xFFF6)
#define IRR1A     IRR1_BIT.b7 /* Timer A interrupt request flag */
#define IENR1      *(volatile unsigned char *)0xFFF3 /* Interrupt enable register 1 */
#define IENR1_BIT  (*(struct BIT *)0xFFF3)
#define IENTA     IENR1_BIT.b7 /* Timer A interrupt enable */

#define IRR2       *(volatile unsigned char *)0xFFF7 /* Interrupt request register 2 */
#define IRR2_BIT   (*(struct BIT *)0xFFF7)
#define IRR2C     IRR2_BIT.b1 /* Timer C interrupt request flag */
#define IENR2      *(volatile unsigned char *)0xFFF4 /* Interrupt enable register 2 */
#define IENR2_BIT  (*(struct BIT *)0xFFF4)
#define IENTC     IENR2_BIT.b1 /* Timer C interrupt enable */

#pragma interrupt (tmra)
#pragma interrupt (tmrc)

/* Function definition */
extern void INIT(void); /* Stack pointer set */
void main(void); /* main routine */
void tmra(void); /* Timer A interrupt routine */
void tmrc(void); /* Timer C interrupt routine */
void ADC_Init(void); /* ADC initialize */
void DataIn(int ByteNo); /* ADC read */
void DataOut(int ByteNo); /* ADC write */

/* Data table */
const unsigned char dsp_data[16] =
{
    0x3f, /* LED display data = "0" */
    0x06, /* LED display data = "1" */
    0x5b, /* LED display data = "2" */
    0x4f, /* LED display data = "3" */
    0x66, /* LED display data = "4" */
    0x6d, /* LED display data = "5" */
    0x7d, /* LED display data = "6" */
    0x27, /* LED display data = "7" */
    0x7f, /* LED display data = "8" */
    0x6f, /* LED display data = "9" */
    0x77, /* LED display data = "A" */
    0x7c, /* LED display data = "b" */
    0x39, /* LED display data = "C" */
    0x5e, /* LED display data = "d" */
    0x79, /* LED display data = "E" */
    0x71, /* LED display data = "F" */
};

/* RAM define */
unsigned char dig_0; /* Dig-0 LED display data store */
```

```

unsigned char dig_1;          /* Dig-1 LED display data store */
unsigned char dig_2;          /* Dig-2 LED display data store */
unsigned char dig_3;          /* Dig-3 LED display data store */
unsigned char cnt;            /* LED enable counter */
unsigned int temp;
unsigned char *ptr;           /* Pointer set */
volatile unsigned char sdata[5]; /* send data area */
volatile unsigned char rdata[5]; /* receive data area */

/* Vector address */
#pragma section V1            /* Vector section set */
void (*const VEC_TBL1[]) (void) = {
    INIT                      /* H'0000 Reset vector */
};
#pragma section V2            /* Vector section set */
void (*const VEC_TBL2[]) (void) = {
    tmra                      /* H'0016 Timer A interrupt vector */
};
#pragma section V3            /* Vector section set */
void (*const VEC_TBL3[]) (void) = {
    tmrc                      /* H'001a Timer C interrupt vector */
};
#pragma section              /* P */

/*****
/* Main program */
*****/
void main(void)
{
    set_imask_ccr(1);         /* CCR I-bit = 1 */

    dig_0 = 0x40;             /* Used RAM area initialize */
    dig_1 = 0x40;             /* Used RAM area initialize */
    dig_2 = 0x40;             /* Used RAM area initialize */
    dig_3 = 0x40;             /* Used RAM area initialize */
    cnt = 0x00;               /* Used RAM area initialize */

    PCR1 = 0x3f;              /* Port 1 initialize */
    PCR4 = 0xfd;              /* Port 4 initialize */
    PCR5 = 0xff;              /* Port 5 initialize */
    PCR6 = 0xff;              /* Port 6 initialize */
    PCR8 = 0xff;              /* Port 8 initialize */

    CS = 1;                   /* CS High */
    PWRON = 0;                /* POWER OFF */
    WU2 = 1;                  /* Wake up OFF */
    WU2 = 1;                  /* Wake up OFF */

    ADC_Init();               /* ADC initialize */

    TMA = 0x0c;               /* Clear Timer Counter A to 0 */
    TMA = 0x09;               /* Timer A initialize */
    TLC = 0x00;               /* Clear Timer Load register C to 0 */
    TMC = 0x1b;               /* Timer C initialize */

```

```

    IRRTA = 0;                /* Clear IRRTA to 0 */
    IRRTC = 0;                /* Clear IRRTC to 0 */
    IENTA = 1;                /* Timer A interrupt enable */
    IENTC = 1;                /* Timer C interrupt enable */

    set_imask_ccr(0);         /* CCR I-bit = 0 */

    while(1);
}

/*****
/* Timer A Interrupt
*****/
void tmra(void)
{
    IRRTA = 0;                /* Clear IRRTA to 0 */

    rdata[0] = 0x00;
    do {
        sdata[0] = 0xcc;      /* Read to Status Register */
        DataIn(1);
    } while((rdata[0] & 0x02) == 0);
    sdata[0] = 0xc4;          /* Read DATA Register value */
    DataIn(2);

    dig_0 = dsp_data[rdata[1] & 0x0f]; /* Dig-0 LED display data set */
    dig_1 = dsp_data[rdata[1] >> 4 & 0x0f]; /* Dig-1 LED display data set */
    dig_2 = dsp_data[rdata[0] & 0x0f]; /* Dig-2 LED display data set */
    dig_3 = dsp_data[rdata[0] >> 4 & 0x0f]; /* Dig-3 LED display data set */
}

/*****
/* Timer C Interrupt
*****/
void tmrc(void)
{
    IRRTC = 0;                /* Clear IRRTC to 0 */

    ptr = &dig_0;             /* LED display data store address set */
    ptr += cnt;                /* LED display data read */
    PDR5 = *ptr;               /* LED display data output */
    PDR6 = cnt;                /* LED enable data output */

    cnt++;                     /* "cnt" increment */
    if (cnt >= 4){              /* 4 times end ? */
        cnt = 0;                /* "cnt" initialize */
    }
}

/*****
/* ADC initialize function
*****/
void ADC_Init(void)

```

```

{
    long i;

    PWRON = 1;                                /* POWER ON */

    for(i=0;i<10000;i++);                     /* delay */
    WU1 = 0;

    sdata[0] = 0xba;                          /* Write RUN Register */
    DataOut(1);

    sdata[0] = 0xb0;                          /* Write POWER1 Register */
    sdata[1] = 0xf0;
    DataOut(2);

    sdata[0] = 0x82;                          /* Write MUX Register */
    sdata[1] = 0x61;
    DataOut(2);

    sdata[0] = 0x80;                          /* Write ADC Register */
    sdata[1] = 0x11;
    DataOut(2);
}

/*****
/* ADC register write and read function */
*****/
void DataIn(int ByteNo)
{
    int cSclk, Dcnt, maxdcnt, i, Pcnt;
    unsigned char BitPos;

    rdata[0] = rdata[1] = 0x00;               /* data area initialize */

    maxdcnt = (ByteNo << 4);
    Dcnt = Pcnt = 0;                          /* counter initialize */
    BitPos = 0x80;                            /* bit position initialize */
    CS = 0;                                   /* CS ON */
    SCLK = cSclk = 0;                         /* SCLK Low */
    if(sdata[Dcnt] & BitPos)                  /* output data */
        DOUT = 1;
    else
        DOUT = 0;
    BitPos >>= 1;                             /* next bit position*/

    /* write register */
    while(1){
        for(i=0;i<10;i++);                   /* delay */
        cSclk ^= 1;
        SCLK = cSclk;                         /* output reverse SCLK */
        if(Pcnt & 0x01){
            if((Pcnt % 16) != 15){            /* last bit ?*/
                if(sdata[Dcnt] & BitPos)      /* output data */
                    DOUT = 1;
            }
        }
    }
}

```

```

        else
            DOUT = 0;
            BitPos >>= 1; /* next bit position*/
        } else {
            for(i=0;i<10;i++); /* delay */
            SCLK = 0; /* SCLK Low */
            DOUT = 1; /* DOUT Low */
            break;
        }
    }
    Pcnt++; /* pulse count increment */
}

/* read register */
Dcnt = Pcnt = 0; /* SCLK count */
BitPos = 0x80; /* bitb position initialize */
while(1){
    if((Pcnt & 0x01) == 0x00) {
        if(DIN)
            rdata[Dcnt] |= BitPos; /* input data */
            BitPos >>= 1; /* next bit position*/
        if(Pcnt >= (maxdcnt - 1)) { /* end ? */
            for(i=0;i<10;i++); /* delay */
            SCLK = 0; /* SCLK Low */
            for(i=0;i<10;i++); /* delay */
            CS = 1; /* CS High */
            return;
        } else if(((Pcnt % 16) == 0) && (Pcnt != 0)){ /* next data */
            BitPos = 0x80; /* bitb position initialize */
            Dcnt++; /* data count increment */
            if(DIN) /* input data */
                rdata[Dcnt] |= BitPos;
                BitPos >>= 1; /* next bit position*/
        }
    }
    cSclk ^= 1;
    SCLK = cSclk; /* reverse SCLK */
    Pcnt++; /* pulse count increment */
    for(i=0;i<10;i++); /* delay */
}

/*****
/* ADC register write function */
*****/
void DataOut(int ByteNo)
{
    int cSclk, Dcnt, maxdcnt, i, Pcnt;
    unsigned char BitPos;

    maxdcnt = (ByteNo << 4);
    Dcnt = Pcnt = 0; /* counter initialize */
    BitPos = 0x80; /* bit position initialize */
    CS = 0; /* CS ON */

```

```

SCLK = cSclk = 0;                                /* SCLK Low */
if(sdata[Dcnt] & BitPos)                          /* output data */
    DOUT = 1;
else
    DOUT = 0;
BitPos >>= 1;                                    /* next bit position*/

while(1){
    for(i=0;i<10;i++);                          /* delay */
    cSclk ^= 1;
    SCLK = cSclk;                                /* reverse SCLK */
    if(Pcnt & 0x01) {
        if((Pcnt % 16) != 15){                  /* not last bit ? */
            if(sdata[Dcnt] & BitPos)             /* output data */
                DOUT = 1;
            else
                DOUT = 0;
            BitPos >>= 1;                        /* next bit position*/
        } else {
            if(Pcnt >= (maxdcnt - 1)) {          /* end ? */
                for(i=0;i<10;i++);              /* delay */
                SCLK = 0;                       /* SCLK Low */
                DOUT = 1;                       /* output High */
                for(i=0;i<10;i++);              /* delay */
                CS = 1;                         /* CS OFF */
                return;
            } else {
                BitPos = 0x80;                  /* bit position initialize */
                Dcnt++;                          /* data count increment */
                if(sdata[Dcnt] & BitPos)         /* output data */
                    DOUT = 1;
                else
                    DOUT = 0;
                BitPos >>= 1;                    /* next bit position*/
            }
        }
    }
    Pcnt++;                                       /* pulse count increment */
}

```

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sept.19.03	—	First edition issued

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